

Vishay Siliconix

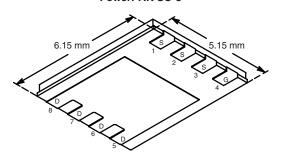
HALOGEN

FREE

Available

## P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
- 30	0.0065 at V <sub>GS</sub> = - 10 V	- 35	100 nC		
	PowerPAK SO-8				



Bottom View

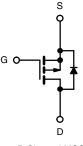
Ordering Information: Si7447ADP-T1-E3 (Lead (Pb)-free) Si7447ADP-T1-GE3 (Lead (Pb)-free and Halogen-free)

### FEATURES

- Halogen-free According to IEC 61249-2-21
  Available
- TrenchFET<sup>®</sup> Power MOSFET
- New Low Thermal Resistance PowerPAK<sup>®</sup> Package with Low 1.07 mm Profile
- 100 % R<sub>a</sub> Tested

#### **APPLICATIONS**

- Battery and Load Switching
  Notebook Computers
  - Notebook Battery Packs



P-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 30	- V		
Gate-Source Voltage	V <sub>GS</sub>	± 25			
	T <sub>C</sub> = 25 °C		- 35		
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C		- 28		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 21.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 17 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	- 60	— A	
Cantinuaus Courses Drain Diada Current	T <sub>C</sub> = 25 °C	L.	- 28		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 4.3 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	40		
Avalanche Energy L = 0.		E <sub>AS</sub>	80	mJ	
	T <sub>C</sub> = 25 °C		83.3		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	PD	53.3		
	T <sub>A</sub> = 25 °C	FD	5.4 <sup>b, c</sup>	- W	
	T <sub>A</sub> = 70 °C		3.4 <sup>b, c</sup>	1	
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	O		
Soldering Recommendations (Peak Temperature		260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	18	23	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	1.0	1.3	0/11	

Notes:

a. Based on  $T_C = 25$  °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See Solder Profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 65 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · · · · ·					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 33		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	iD = - 200 μA		5.3			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = -250 \ \mu {\rm A}$		- 2.0	- 3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 1	μΑ	
Zero Gale voltage Drain Current		$V_{DS} = -30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ - 5 V, $V_{GS}$ = - 10 V	- 30			А	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 24 A		0.0054	0.0065	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 24 A		50		S	
Dynamic <sup>b</sup>		· · · · · · · · · · · · · · · · · · ·					
Input Capacitance	C <sub>iss</sub>			4650		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1200			
Reverse Transfer Capacitance	C <sub>rss</sub>			930			
Total Gate Charge	Qg			100	150	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 15 V, $V_{GS}$ = - 10 V, $I_{D}$ = - 24 A		15.5			
Gate-Drain Charge	Q <sub>gd</sub>			25			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	1.7	3.5	5.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, R <sub>L</sub> = 1.5 Ω $I_D \cong$ - 10 A, V <sub>GEN</sub> = - 10 V, R <sub>g</sub> = 1 Ω		25	40	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			82	125		
Fall Time	t <sub>f</sub>			98	150		
Drain-Source Body Diode Characterist	ics	· · · · · ·					
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 28	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 60		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 4.3 A		- 0.72	- 1.1	V	
Body Diode Reverse Recovery Time				47	70	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 19 A, dl/dt = - 100 A/μs, T <sub>J</sub> = 25 °C		50	75	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$F = -10 \text{ A}, \text{ ava} = -100 \text{ A/} \mu \text{s}, 1 \text{ J} = 25 \text{ °C}$		22			
Reverse Recovery Rise Time	ry Rise Time t <sub>b</sub>			25		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



## Si7447ADP Vishay Siliconix

55 °C

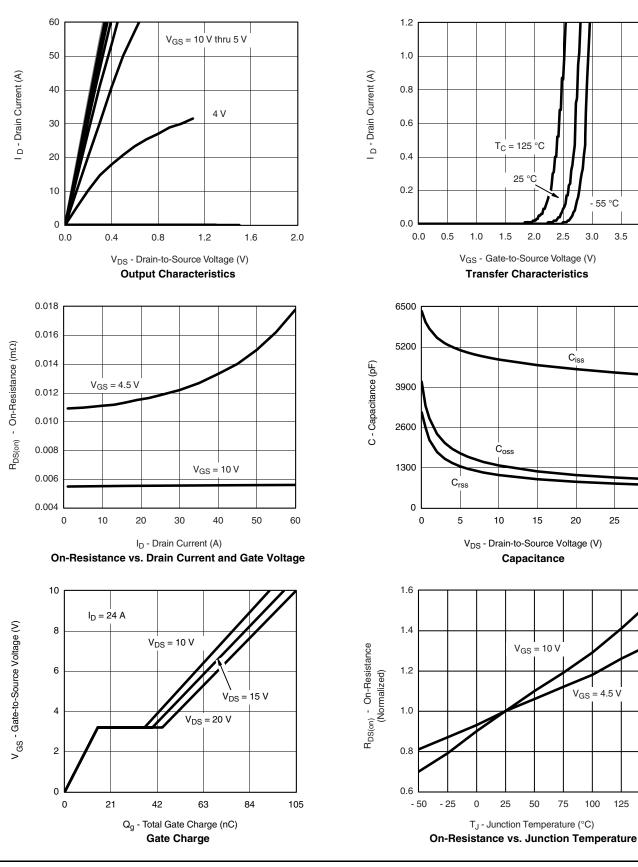
3.5

4.0

30

25

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

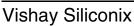


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125

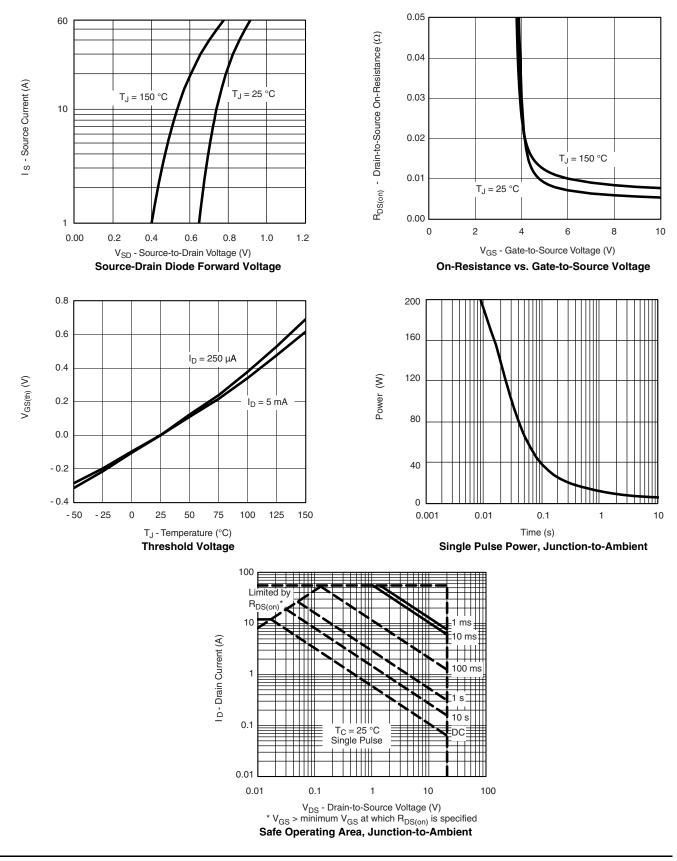
150

# Si7447ADP



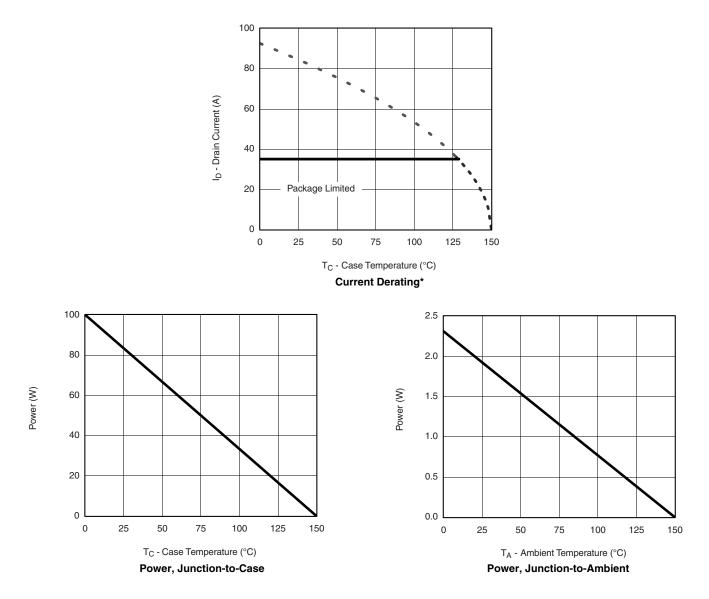


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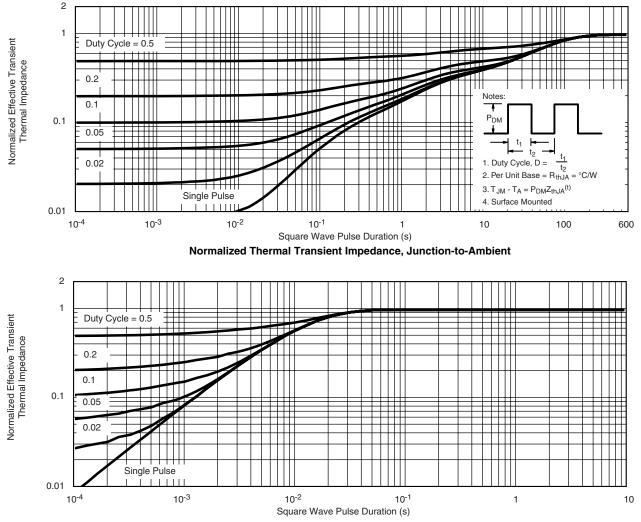


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?73358">www.vishay.com/ppg?73358</a>.



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